



# Product Change Notification

**Change Notification #:** 115184 - 00  
**Change Title:** Intel® NUC Kit, NUC6i7KYK,  
PCN 115184-00, Product Design,  
Chassis Modification  
**Date of Publication:** December 13, 2016

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Dec 30, 2016
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## Description of Change to the Customer:

The Intel® NUC Kit SKUs listed in the products affected table below will have the following change.

- The design of the mid frame has been changed to improve bottom cover attachment.

## Customer Impact of Change and Recommended Action:

This change has been thoroughly evaluated to ensure there is no quality, reliability, or functional implication to our customers. Intel is not recommending additional qualification of these changes on platforms received from Intel.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions. Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

## Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change SA	Post Change SA
BOXNUC6I7KYK	944578	H90754-105	H90754-106
BOXNUC6I7KYK1	944579	H90755-105	H90755-106
BOXNUC6I7KYK2	944580	H90756-105	H90756-106
BOXNUC6I7KYK3	944581	H90757-105	H90757-106
BOXNUC6I7KYK4	944582	H90758-105	H90758-106

## PCN Revision History:

<b>Date of Revision:</b> December 13, 2016	<b>Revision Number:</b> 00	<b>Reason:</b> Originally Published PCN
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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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